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RENESAS

Application Note

78K0/Kx2-L

Sample Program (Operational Amplifier)

Amplifying Analog Voltages in PGA Mode

This document describes an operation overview of the sample program and how to use it, as well as how to set up and use the operational amplifier. In the sample program, the analog voltage amplified using operational amplifier 0 in PGA mode is A/D converted using the A/D converter, and then the conversion results and the average of four conversion results are saved in the RAM area.

Target devices 78K0/KY2-L microcontroller 78K0/KA2-L microcontroller 78K0/KB2-L microcontroller 78K0/KC2-L microcontroller

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CHAPTER 1 OVERVIEW

An example of using the operational amplifier is presented in this sample program. The analog voltage amplified using operational amplifier 0 in PGA mode is A/D converted using the A/D converter, and then the conversion results and the average of four conversion results are saved in the RAM area.

1.1 Primary Initial Settings

The primary initial settings are as follows:

<Option byte settings>

- Allowing the internal low-speed oscillator to be programmed to stop
- Disabling the watchdog timer
- Setting the internal high-speed oscillation clock frequency to 8 MHz
- Disabling LVI from being started by default

<Settings during initialization immediately after a reset ends>

- Specifying the ROM and RAM sizes
- Setting up I/O ports
 - Specifying the P21/PGAIN pin as an analog input pin
- Checking whether VDD is 2.7 V or more by using the low-voltage detector Note
- Specifying that the CPU clock and peripheral hardware clock run on the internal high-speed oscillation clock (8 MHz)
- Stopping the internal low-speed oscillator
- Disabling peripheral hardware not to be used
- Setting up operational amplifier 0
 - Specifying the PGA mode as the operating mode
 - Setting the gain to fourfold
- Setting up the A/D converter^{Note}
 - Specifying the standard mode as the operating mode and 264/fprs (about 33 μ s) as the conversion time
 - Specifying PGAIN as the analog input channel
 - Enabling the INTAD interrupt for exiting the HALT mode during A/D conversion

Note For details about the low-voltage detector and A/D converter, refer to the 78K0/Kx2-L User's Manual.

1.2 Processing After Main Loop

After the initial settings have been specified, A/D conversion starts, the amplified analog voltage from the PGAIN pin is input to the A/D converter and A/D converted four times, the correction value for the input offset voltage of PGA is added to the conversion results, and then the results are saved in the RAM area. After the four conversion results are saved, A/D conversion is stopped. After A/D conversion is stopped, the average of four A/D conversion results is calculated and saved in the RAM area.

[Operation overview]



1.3 PGA Mode

(1) Example of using the PGA mode

When operational amplifier 0 is used in the PGA mode, the analog voltage input from the PGAIN pin can be amplified using the programmable gain amplifier (PGA) in the microcontroller. The amplified voltage can be input to the A/D converter.

An example of using the PGA mode is shown below.



In the figure above, the analog voltage from the variable resistor (VR) connected to the PGAIN pin is amplified by the gain selected using the AMPOM register (fourfold, eightfold, sixteen-fold, or thirty-two-fold), and then output to the A/D converter.

In this sample program, the gain is fourfold.

Caution The PGA input voltage range is from 0.1AVREF divided by the gain to 0.9AVREF divided by the gain. When a variable resistor (VR) is used to input an analog voltage as shown above, make sure that the analog voltage input to the PGAIN pin is in that range by connecting fixed resistors (R1 and R2) between VR and AVREF and VR and GND.

The following equations show the relationship between VR, R1, and R2:

(R1 + R2 + VR) : (R2 + VR) = 10 : 9/Gain (R1 + R2 + VR) : R2 = 10 : 1/Gain

In this sample program, because the gain is fourfold, the analog voltage input to the PGAIN pin is in the range from 0.1AVREF divided by 4 to 0.9AVREF divided by 4 by using 1 k Ω for VR, 4.3 k Ω for R1, and 130 Ω for R2.

(2) Input offset voltage

An input offset voltage of up to $\pm 10 \text{ mV}$ is generated for the PGA. Therefore, the target output voltage (the analog voltage input to the PGAIN pin \times gain) differs from the actual output voltage. Therefore, when performing A/D conversion on the output of the PGA, the A/D conversion results must be corrected in accordance with the input offset voltage.

In this sample program, a correction value of -5^{Note} is added to the A/D conversion results to handle the effects of the input offset voltage.

Note The input offset voltage varies depending on the device used and the operating environment. When adding a correction value to the A/D conversion results, adjust the correction value in accordance with the input offset voltage.

CHAPTER 2 CIRCUIT DIAGRAM

This chapter provides a circuit diagram used in this sample program.

2.1 Circuit Diagram

A circuit diagram is shown below.



- Notes 1. This is shared with AVss in the 78K0/KY2-L and 78K0/KA2-L.
 - 2. This is provided only in the 78K0/KB2-L and 78K0/KC2-L.
- Cautions 1. Use the microcontroller at a voltage in the range of 2.94 V \leq V DD \leq 5.5 V.
 - 2. Connect REGC to Vss via a capacitor (0.47 to 1 μ F).
 - 3. For the 78K0/KY2-L and 78K0/KA2-L, Vss is also used as the ground potential for the A/D converter. Be sure to connect Vss to a stable GND.
 - 4. Make the AVss pin have the same potential as Vss and connect it directly to GND (only for the 78K0/KB2-L and 78K0/KC2-L microcontrollers).
 - 5. Make sure that the AVREF voltage is 2.7 V or more, 5.5 V or less, and VDD or less.
 - 6. Handle unused pins that are not shown in the circuit diagram as follows:
 - I/O ports: Set them to output mode and leave them open (unconnected).
 - Input ports: Connect them independently to VDD or VSS via a resistor.
 - 7. In this sample program, the P121/X1/TOOLC0 and P122/X2/EXCLK/TOOLD0 pins are used for on-chip debugging.
 - For details about the resistance of the resistors to connect to the PGAIN pin, refer to <u>1.3 PGA</u> <u>Mode</u>.

CHAPTER 3 SOFTWARE

This chapter describes the files included in the compressed file to be downloaded, internal peripheral functions of the microcontroller to be used, and initial settings and provides an operation overview of the sample program and the flow charts.

3.1 Included Files

The following table shows the files included in the compressed file to be downloaded.

File Name	Description	Compresse Inclu	d (*.zip) File uded
		Ð	모 제 1 1 - <mark>- 32</mark>
main.asm (Assembly language version)	Source file for hardware initialization processing and main processing of microcontroller	● Note	● Note
main.c (C language version)			
op.asm	Assembler source file for setting the option byte (This file is used for setting up the watchdog timer and internal low-speed oscillator and selecting the internal high-speed oscillation clock frequency.)	•	•
Kx2-L_AMP.prw	Work space file for integrated development environment PM+		•
Kx2-L_AMP.prj	Project file for integrated development environment PM+		•

Note "main.asm" is included with the assembly language version, and "main.c" with the C language version.

Remark

ZIP

: Only the source file is included.

: The files to be used with integrated development environment PM+ are included.

3.2 Internal Peripheral Functions to Be Used

The following internal peripheral functions of the microcontroller are used in this sample program.

(1) Peripheral hardware

- Operational amplifier 0: Used to amplify the analog voltage.
- A/D converter: Performs 10-bit resolution A/D conversion.
- Low-voltage detector: Used to check that VDD is 2.7 V or more.

(2) Pin

• P21/PGAIN: Used as the PGA input of operational amplifier 0.

3.3 Initial Settings and Operation Overview

In this sample program, initial settings including the selection of the clock frequency, setting of the I/O ports, and setting of operational amplifier 0 are performed. After the initial settings have been specified, A/D conversion starts, the amplified analog voltage from the PGAIN pin is input to the A/D converter and A/D converted four times, the correction value for the input offset voltage of the PGA is added to the conversion results, and then the results are saved in the RAM area. After the four conversion results are saved, A/D conversion is stopped. After A/D conversion is stopped, the average of four A/D conversion results is calculated and saved in the RAM area.

The details are described in the status transition diagram shown below.



3.4 Flow Charts

The flow charts for the sample program are shown below.



- **Notes 1.** The option byte is automatically referenced by the microcontroller immediately after a reset ends. In this sample program, the following settings are specified using the option byte:
 - Allowing the internal low-speed oscillator to be programmed to stop
 - Disabling the watchdog timer
 - Setting the internal high-speed oscillation clock frequency to 8 MHz
 - Disabling LVI from being started by default
 - 2. The low-voltage detector is enabled, and then the system is made to wait at least 10 μ s until the low-voltage detector stabilizes.
 - **3.** A correction value of -5 is added to the A/D conversion results to handle the effects of the input offset voltage of the PGA.
 - **4.** A/D conversion starts after the system waits for 1 μs until operation stabilizes after the A/D voltage comparator is started.
 - 5. To reduce the effects of noise, the HALT mode is entered until A/D conversion ends.

CHAPTER 4 SETTING METHODS

This chapter describes how to set up operational amplifier 0 and provides software coding examples.

For details about the A/D converter settings, refer to the <u>78K0/Kx2-L Sample Program (A/D Converter) Successive</u> <u>A/D Conversion & Average Value Calculation Application Note</u>.

For other initial settings, refer to the <u>78K0/Kx2-L Sample Program (Initial Settings) LED Lighting Switch Control</u> <u>Application Note</u>.

For how to set registers, refer to the <u>78K0/Kx2-L User's Manual</u>.

For assembler instructions, refer to the 78K/0 Series Instructions User's Manual.

4.1 Setting up Operational Amplifier 0

Operational amplifier 0 uses the following registers:

- Operational amplifier 0 control register (AMP0M)
- A/D port configuration register 0 (ADPC0)
- Port mode register 2 (PM2)

[Example of the setup procedure when outputting the analog voltage amplified in PGA mode to the A/D converter]

- <1> Use the ADPC0 register to specify the pin to be used in the PGA mode (PGAIN) as an analog input pin.
- <2> Use the PM2 register to specify the pin to be used in the PGA mode (PGAIN) as an input pin.
- <3> Use the AMP0VG0 and AMP0VG1 bits of the AMP0M register to select the gain (fourfold, eightfold, sixteenfold, or thirty-two-fold).
- <4> Set the PGAEN bit of the AMPOM register to 1 to enable operation in PGA mode.
- <5> Use the ADS register of the A/D converter to specify PGAIN as the analog input channel.

(1) Operational amplifier 0 control register (AMP0M)

This register controls the operation of operational amplifier 0.

OPAMP0E	PGAEN	0	0	0	0	AMP0VG1	AMP0VG0
		_					
			AMP0VG1	AMP0VG0	PGA mo	ode of operation	al amplifier 0 gain selection
		L	0	0	×4		
			0	1	×8		
			1	0	×16		
			1	1	×32		
			OPAMP0E	PGAEN	Op	perational ampli	fier 0 operation control
			0	0	Stops op	erational amplifi	ier 0 operation
			0	1	Enables operation	operational amp	olifier 0 (PGA mode only)
			1	0	Enables on mode on	operational amp ly) operation	lifier 0 (single-amplifier
			1	1	Enables operation operation	operational amp in the PGA and	lifier 0 (simultaneous d single-amplifier modes)

Figure 4-1. Format of Operational Amplifier 0 Control Register (AMP0M)

Cautions 1. When using the PGA mode, use the ADPC0 register to select the PGAIN/AMP0OUT/ANI1/P21 pin as an analog input.

- 2. When using the single-amplifier mode, use the ADPC0 register to select the AMP0OUT/PGAIN/ANI1/P21, AMP0-/ANI0/P20, and AMP0+/ANI2/P22 pins as analog inputs.
- 3. When using as digital inputs the pins of port 2, which are not used with operational amplifier 0, when operational amplifier 0 is used, make sure that the input levels are fixed.
- 4. Be sure to clear bits 5 to 2 to "0".

Remark The values written in red in the above figure are specified in this sample program.

(2) A/D port configuration register 0 (ADPC0)

ADPC0 switches the P20/AMP0-/ANI0 to P27/ANI7 pins to digital I/O or analog input of port. Each bit of ADPC0 corresponds to a pin of port 2 and can be specified in 1-bit units.

Specify the pins to be used in the PGA mode or single-amplifier mode as analog input pins by using ADPC0.



Figure 4-2. Format of A/D Port Configuration Register 0 (ADPC0)

- Notes 1. This bit can be set only in the 78K0/KC2-L. Be sure to clear this bit to 0 in the 78K0/KY2-L, 78K0/KA2-L, and 78K0/KB2-L.
 - 2. This bit can be set only in the 78K0/KA2-L and 78K0/KC2-L. Be sure to clear this bit to 0 in the 78K0/KY2-L and 78K0/KB2-L.

Cautions 1. Set the pin set to analog input to the input mode by using port mode register 2 (PM2).

2. If data is written to ADPC0, a wait cycle is generated. Do not write data to ADPC0 when the peripheral hardware clock (fPRs) is stopped.

Remark The values written in red in the above figure are specified in this sample program.

(3) Port mode register 2 (PM2)

When using PGAIN/AMP0OUT/ANI1/P21 for operational amplifier 0, set PM21 to 1. The output latch of P21 at this time may be 0 or 1. If PM21 is set to 0, it cannot be used as the operational amplifier 0 pin.

Figure 4-3. Format of Port Mode Register 2 (PM2)



- Notes 1. This bit can be set only in the 78K0/KC2-L. Be sure to set this bit to 1 in the 78K0/KY2-L, 78K0/KA2-L, and 78K0/KB2-L.
 - 2. This bit can be set only in the 78K0/KA2-L and 78K0/KC2-L. Be sure to set this bit to 1 in the 78K0/KY2-L and 78K0/KB2-L.
- **Remark** The values written in red in the above figure are specified in this sample program.

(4) Analog input channel specification register (ADS)

This register specifies the analog input channel of the A/D converter. The analog voltage input from the PGAIN pin of operational amplifier 0 can be input to the A/D converter after amplifying it in PGA mode.

0	ADO	AS	0		0	AD	S3	ADS2	ADS1	ADS0
				1000	4000		4000			
			ADOAS	ADS3	ADS2	ADS1	ADS0	Analog	g input channel	Input source
			0	0	0	0	0	ANI0		P20/ANI0 pin
			0	0	0	0	1	ANI1		P21/ANI1 pin
			0	0	0	1	0	ANI2		P22/ANI2 pin
			0	0	0	1	1	ANI3		P23/ANI3 pin
			0	0	1	0	0	ANI4		P24/ANI4 pin
			0	0	1	0	1	ANI5		P25/ANI5 pin
			0	0	1	1	0	ANI6		P26/ANI6 pin
			0	0	1	1	1	ANI7		P27/ANI7 pin
			0	1	0	0	0	ANI8		P10/ANI8 pin
			0	1	0	0	1	ANI9		P11/ANI9 pin
			0	1	0	1	0	ANI10		P12/ANI10 pin
			1	x	x	X	x	PGAIN		PGA output signal
	Other than the above							Setting p	prohibited	

Figure 4-4. Format of Analog Input Channel Specification Register (ADS)

Cautions 1. Be sure to clear bits 7, 5, and 4 to "0".

- 2. Set a channel to be used for A/D conversion in the input mode by using port mode register 2 (PM2).
- 3. Set ADS after PGA operation setting when selecting the PGA output signal as analog input.
- 4. If data is written to ADS, a wait cycle is generated. Do not write data to ADS when the peripheral hardware clock (fprs) is stopped.
- Remarks 1. A/D converter analog input pins differ depending on products.
 - 78K0/KY2-L: ANI0 to ANI3
 - 78K0/KA2-L: ANI0 to ANI5
 - 78K0/KB2-L: ANI0 to ANI3, ANI8 to ANI10
 - 78K0/KC2-L: ANI0 to ANI10
 - 2. The values written in red in the above figure are specified in this sample program.
 - 3. x: don't care

4.2 Software Coding Example

The settings to be specified for operational amplifier 0 in the 78K0/KC2-L source program are shown below as a software coding example.

For details about the registers used for the A/D converter (ADCE, ADCS, and ADCR), refer to the <u>78K0/Kx2-L</u> Sample Program (A/D Converter) Successive A/D Conversion & Average Value Calculation Application Note.

(1) Assembly language



(2) C language



CHAPTER 5 RELATED DOCUMENTS

The related documents indicated in this publication may include preliminary versions. However, preliminary versions are not marked as such.

	English			
78K0/Kx2-L User's Man	ual		<u>PDF</u>	
78K/0 Series Instruction	ns User's Manual		PDF	
RA78K0 Assembler Pac	PDF			
		Operation	PDF	
CC78K0 C Compiler Us	<u>PDF</u>			
		Operation	<u>PDF</u>	
PM+ Project Manager U	<u>PDF</u>			
78K0/Kx2-L	Sample Program (Initial Settings) LED Lightin	<u>PDF</u>		
Application Note	Sample Program (A/D Converter) Successive Value Calculation	ample Program (A/D Converter) Successive A/D Conversion & Average lue Calculation		

APPENDIX A PROGRAM LIST

As a program list example, the 78K0/KC2-L microcontroller source program is shown below.

```
    main.asm (assembly language version)

 ;
     NEC Electronics
                    78K0/KC2-L Series
 ;
 78K0/KC2-L Series Sample Program (Operational Amplifier)
 Amplifying Analog Voltages in PGA Mode
 ;<<History>>
     2009.1.--
               Release
 ;<<Overview>>
 ; This sample program presents an example of using the operational amplifier.
 ; The analog voltage amplified using operational amplifier 0 in PGA mode is
 ; A/D converted using the A/D converter, and then the conversion results and
 ; the average of four conversion results are saved in the RAM area.
 ; < Primary initial settings>
 ; (Option byte settings)
 ; - Allowing the internal low-speed oscillator to be programmed to stop
 ; - Disabling the watchdog timer
 ; - Setting the internal high-speed oscillation clock frequency to 8 MHz
 ; - Disabling LVI from being started by default
 ; (Settings during initialization immediately after a reset ends)
 ; - Specifying the ROM and RAM sizes
 ; - Setting up I/O ports
    \rightarrow Specifying the P21/PGAIN pin as an analog input pin
 ; - Checking whether VDD is 2.7 V or more by using the low-voltage detector
 ; - Specifying that the CPU clock and peripheral hardware clock run on the internal
    high-speed oscillation clock (8 MHz)
 ; - Stopping the internal low-speed oscillator
 ; - Disabling peripheral hardware not to be used
 ; - Setting up operational amplifier 0
  \rightarrow Specifying the PGA mode as the operating mode
 ;
   \rightarrow Setting the gain to fourfold
 ; - Setting up the A/D converter
```

```
; \rightarrow Specifying the standard mode as the operating mode and 264/fPRS (about 33 us) as
```

the conversion time → Specifying PGAIN as the analog input channel : \rightarrow Enabling the INTAD interrupt \rightarrow Enabling the INTAD interrupt for exiting the HALT mode during A/D conversion ; : ; <Area in which to save the A/D conversion results> ; | Data Type | Variable Name ; |-----| ; | A/D conversion result (1st time) | RADCBUF + 0 ; | A/D conversion result (2nd time) | RADCBUF + 2 ; | A/D conversion result (3rd time) | RADCBUF + 4 ; | A/D conversion result (4th time) | RADCBUF + 6 ; | A/D conversion result (average) | RADCAVR : +-----+ ; ; ; <I/O port settings> ; Input: P21 * Set all unused ports that can be specified as output ports as output ports. ; ; Vector table ; XVECT1 CSEG AT 0000H RESET_START DW ;0000H RESET input, POC, LVI, WDT XVECT2 CSEG AT 0004H DW IINIT ;0004H INTLVI DW IINIT ;0006H INTP0 ;0008H INTP1 DW IINIT ;000AH INTP2 DW IINIT ;000CH INTP3 DW IINIT DW IINIT ;000EH INTP4 ;0010H INTP5 DW IINIT DW IINIT ;0012H INTSRE6 DW IINIT ;0014H INTSR6 IINIT ;0016H INTST6 DW DW IINIT ;0018H INTCSI10 ;001AH INTTMH1 DW IINIT ;001CH INTTMH0 DW TINIT DW IINIT ;001EH INTTM50

;0020H INTTM000 DW IINIT ;0022H INTTM010 DW IINIT DW IINIT ;0024H INTAD ;0026H INTP6 DW IINIT IINIT ;0028H INTRTCI DW ;002AH INTTM51 DW IINIT IINIT ;002CH INTKR DW DW IINIT ;002EH INTRTC ;0030H INTP7 DW IINIT IINIT ;0032H INTP8 DW DW IINIT ;0034H INTIICA0 IINIT ;0036H INTCSI11 DW ;0038H INTP9 IINIT DW IINIT ;003AH INTP10 DW DW IINIT ;003CH INTP11 ;003EH BRK IINIT DW ; Define the ROM data table ; XTBL CSEG AT 0200H TADCADJ: DW 0005H ; A/D conversion result correction value -5 ; *For handling the effects of the input offset voltage of the PGA : ; Define the RAM data table DRAM DSEG SADDRP RADCBUF: DS ; Area in which to save the A/D conversion results 8 RADCAVR: DS 2 ; Average A/D conversion result RADCADJ: DS 2 ; Corrected A/D conversion result ; Define the memory stack area ; DSTK DSEG IHRAM STACKEND: DS 20H ; Memory stack area = 32 bytes STACKTOP: ; Start address of the memory stack area

; Servicing interrupts by using unnecessary interrupt sources ; CSEG UNIT XMATN IINIT: If an unnecessary interrupt occurred, the processing branches to this line. The processing then returns to the initial original processing because no processing is performed here. RETI ; Initialization after RESET : RESET START: ;-------Disable interrupts DT ; Disable interrupts Set up the register bank ;------SEL RB0 ; Set up the register bank ;------Specify the ROM and RAM sizes Note that the values to specify vary depending on the model. Enable the settings for the model to use. (The uPD78F0588 is the default model.) ;------; Setting when using uPD78F0586 ;MOV IMS, #042H ; Specify the ROM and RAM sizes ; Setting when using uPD78F0587 ;MOV IMS, #004H ; Specify the ROM and RAM sizes ; Setting when using uPD78F0588 MOV IMS, #0C8H ; Specify the ROM and RAM sizes Initialize the stack pointer ;-----

MOVW SP, #STACKTOP ; Initialize the stack pointer Initialize port 0 РО, #00000000B ; Set the P00 to P02 output latches to low level MOV MOV PM0, #11111000B ; Specify P00 to P02 as output ports ; P00 to P02: Unused Initialize port 1 ADPC1, #00000111B ; Specify P10 to P12 as digital I/O ports MOV #00000000B ; Set the P10 to P17 output latches to low level MOV Ρ1, MOV PM1, #0000000B ; Specify P10 to P17 as output ports ; P10 to P17: Unused ;-------Initialize port 2 MOV ADPC0, #11111101B ; Specify P21 as an analog input pin ; Specify P20, P22 to P27 as digital I/O pins MOV P2, #00000000B ; Set the P20 to P27 output latches to low level MOV PM2, #00000010B ; Specify P21 as an input port ; Specify P20, P22 to P27 as output ports ; P21: Use as PGAIN ; P20, P22 to P27: Unused ;-------Initialize port 3 ;------MOV P3, #0000000B ; Set the P30 to P33 output latches to low level MOV PM3, #11110000B ; Specify P30 to P33 as output ports ; P30 to P33: Unused Initialize port 4 MOV P4, #0000000B ; Set the P40 to P42 output latches to low level MOV PM4, #11111000B ; Specify P40 to P42 as output ports ; P40 to P42: Unused Initialize port 6 P6, #0000000B ; Set the P60 to P63 output latches to low level MOV MOV PM6, #11110000B ; Specify P60 to P63 as output ports ; P60 to P63: Unused

Initialize port 7 Ρ7, #0000000B ; Set the P70 to P75 output latches to low level MOV MOV PM7, #11000000B ; Specify P70 to P75 as output ports ; P70 to P75: Unused ;------Initialize port 12 ;------P12, #0000000B ; Set the P120 output latch to low level MOV PM12, #11111110B ; Specify P120 as an output port MOV ; P120 to P125: Unused •_____ Low-voltage detection ;-------The low-voltage detector is used to check whether VDD is 2.7 V or more. ; Set up the low-voltage detector SET1 LVIMK ; Disable the INTLVI interrupt CLR1 LVISEL ; Specify VDD as the detection voltage LVIS, #00001001B ; Set the low-voltage detection level (VLVI) to 2.84 MOV ±0.1 V CLR1 LVIMD ; Specify that an interrupt signal is generated when a low voltage is detected SET1 LVION ; Enable low-voltage detection ; Make the system wait until the low-voltage detector stabilizes (10 us or more) MOV в, #5 ; Specify the number of counts HINI100: NOP DBNZ B, \$HINI100 ; Has the wait period ended? No, ; Make the system wait until VLVI is less than or equal to VDD HINI110: NOP BTLVIF, \$HINI110 ; VDD < VLVI? Yes, CLR1 LVION ; Stop the low-voltage detector ;-------Specify the clock frequency Specify the clock frequency so that the device can run on the internal high-speed oscillation clock. ;------MOV OSCCTL, #0000000B ; Clock operation mode

;		+ +	Be sure to clear this bit to 0
;		++	RSWOSC/AMPHXT
;			[XT1 oscillator oscillation mode selection]
;			00: Low power consumption oscillation
;			01: Normal oscillation
;			1x: Ultra-low power consumption oscillation
;		++	EXCLKS/OSCSELS
;			[Subsystem clock pin operation setting]
;			(P123/XT1, P124/XT2/EXCLKS)
;		11	Specify the use of the pin as an I/O port pin by
, spec:	ifving 000 by a	also using XTS	TART
;		++	EXCLK/OSCSEL
;			[High-speed system clock pin operation setting]
			(P121/X1 P122/X2/FXCLK)
			00. Trait port
			01. X1 oscillation mode
			10. Input port
,			11. External glack input mode
;			II: External Clock input mode
	MOV DCC	#0000000B	· Soloct the CDIL clock (fCDIL)
	100 100,	#00000000D	css/pcc2/pcc1/pcc0
			[CPU clock (fCPU) solection]
,			
i			0000:1AP
;			0001:1AP/2
;			0010:IXP/2"2
;			0011:fXP/2~3
;			0100:fXP/2^4
;			1000:fSUB/2
;			1001:fSUB/2
;			1010:fSUB/2
;			1011:fSUB/2
;			1100:fSUB/2
;			(Other than the above: Setting prohibited)
;		+	Be sure to clear this bit to O
;		+	CLS
;			[CPU clock status]
;		+	XTSTART
;			[Subsystem clock pin operation setting]
;			Specify the use of the pin by also using EXCLKS and
OSCSI	ELS		
;		+	Be sure to clear this bit to O
	MOV RCM,	#00000010B	; Select the operating mode of the internal oscillator
;		+	RSTOP
;			[Internal high-speed oscillator oscillating/stopped]
;			0: Internal high-speed oscillator oscillating
;			1: Internal high-speed oscillator stopped
;		+	LSRSTOP

;				[Internal low-speed oscillator oscillating/stopped]
;				0: Internal low-speed oscillator oscillating
;				1: Internal low-speed oscillator stopped
;			++++	Be sure to clear this bit to 0
;			+	RSTS
;				[Status of internal high-speed oscillator]
	MOV	MOC,	#10000000B	; Select the operating mode of the high-speed system
CLOCK			1	De sume te sleen this hit te 0
;			++++++	Be sure to clear this bit to u
;			+	MSTOP
;				[Control of high-speed system clock operation]
;				0: XI oscillator operating/external clock from
;				EXCLK pin is enabled
;				1: X1 oscillator stopped/external clock from
;				EXCLK pin is disabled
	MOV	MCM,	#00000000B	; Select the clock to supply
;			+ +	XSEL/MCM0:
;				[Clock supplied to main system and
;				peripheral hardware]
;				00: Main system clock (fXP)
;				= internal high-speed oscillation clock (fIH)
;				Peripheral hardware clock (fPRS)
;				= internal high-speed oscillation clock (fIH)
;				01: Main system clock (fXP)
;				= internal high-speed oscillation clock (fIH)
;				Peripheral hardware clock (fPRS)
•				= internal high-speed oscillation clock (fIH)
;				10: Main system clock (fXP)
;				= internal high-speed oscillation clock (fIH)
				Peripheral hardware clock (fPRS)
				- high-speed system clock (ITAB)
				11. Main system clock (fYP)
				- high-speed system clock (fTH)
,				Deripheral hardware glock (FDPC)
				- high grood gustom glock (IFKS)
				- mgn-speed system clock (lin)
;				MCS
;				[Main system clock status]
;			++++	Be sure to clear this bit to U
	MOV	PER0,	#00000000B	; Control the real-time counter control clock
;			++++++	Be sure to clear this bit to 0
;			+	RTCEN:
;				[Real-time counter control clock]
;				0: Stop supply of control clock
;				1: Supply control clock

;------Disable peripheral hardware not to be used ; 16-bit timer/event counter 00 MOV TMC00, #0000000B ; Disable the counter ; 8-bit timer/event counters 50 and 51 MOV тмс50, #0000000В ; Disable timer 50 TMC51, #0000000B ; Disable timer 51 MOV ; 8-bit timers H0 and H1 TMHMD0, #00000000B ; Stop timer H0 MOV #00000000B ; Stop timer H1 MOV TMHMD1, ; Real-time counter MOV RTCC0, #0000000B ; Stop the counter ; Clock output controller MOV CKS, #00000000B ; Stop the clock frequency divider ; Operational amplifier MOV AMP1M, #0000000B ; Stop operational amplifier 1 ; Serial interface UART6 MOV ASIM6, #0000001B ; Disable the interface ; Serial interface IICA IICACTL0,#0000000B ; Disable the interface MOV ; Serial interfaces CSI10 and CSI11 CSIM10, #00000000B ; Disable CSI10 MOV MOV CSIM11, #0000000B ; Disable CSI11 ; Interrupts MOVW MKO, #OFFFFH ; Disable all interrupts MOVW MK1, #OFFFFH ; EGPCTL0,#0000000B ; Disable the detection of all external interrupts MOV EGPCTL1, #0000000B ; MOV ; Key interrupts MOV KRM, #0000000B ; Disable all key interrupts Set up operational amplifier 0 ;-----AMPOM, #01000000B ; Operational amplifier 0 control register MOV |||||++---- AMP0VG1/0 ; [PGA mode of operational amplifier 0 gain selection] ;

00: x4 ; 01: x8 ; 10: x16 ; ; 11: x32 | ++++----- Be sure to clear this bit to 0 ; ----- OPAMP0E/PGAEN • [Operational amplifier 0 operation control] 00: Stop operational amplifier 0 operation ; 01: Enable operational amplifier 0 (PGA mode only) ; operation 10: Enable operational amplifier 0 (single-amplifier ; mode only) operation ; 11: Enable operational amplifier 0 (simultaneous ; operation in the PGA and single-amplifier modes) ; operation ,_____ Set up the A/D converter ADM0, #00000000B ; Specify the standard mode as the operating mode and MOV 264/fPRS as the conversion time MOV ADS, #01000000B ; Specify PGAIN as the analog input channel CLR1 ADIF ; Clear the INTAD interrupt request CLR1 ADMK ; Enable the INTAD interrupt BR MMAIN_LOOP ; Go to the main loop ; Main loop MMAIN_LOOP: ; Read the corrected A/D conversion results !TADCADJ MOVW AX, ; Read the corrected values MOVW ; Store the corrected values in RAM RADCADJ, AX LMAIN010: ;------A/D conversion •_____ SET1 ADCE ; Start the A/D voltage comparator MOVW ; Specify the address of the area in which to save the DE, #RADCBUF A/D conversion results MOV В, #4 ; Specify the number of A/D conversions

MOVW HL, #RADCADJ ; Specify the address of the corrected A/D conversion results LMAIN100: CLR1 ADTF ; Clear the INTAD interrupt request SET1 ADCS ; Start A/D conversion ; Make the system wait until A/D conversion ends HALT ; Enter the HALT mode (Exit the HALT mode by generating an INTAD interrupt) MOVW AX, ADCR ; Read the A/D conversion results CLR1 ; Stop A/D conversion ADCS ; Save and correct the A/D conversion results (to handle the effects of the input offset voltage of the PGA) XCH ; Exchange the higher and lower bytes Α, Х SUB Α, [HL] ; Correct the lower byte MOV [DE], A ; Save the lower byte XCH Α, Х ; Exchange the higher and lower bytes INCW DE ; Go to the higher save area SUBC Α, [HL+1] ; Correct the higher byte MOV [DE], A ; Save the higher byte INCW DE ; Go to the next save area DBNZ ; Have the specified number of A/D conversions been Β, \$LMAIN100 completed? No, CLR1 ADCE ; Stop the A/D voltage comparator ;------Average-value calculation of A/D conversion results : MOVW HL, #RADCBUF ; Specify the address of the area in which to save the A/D conversion results ; Specify the number of A/D conversions used to MOV В, #4 calculate the average MOVW AX, #0000H ; Clear the AX register LMAIN400: XCH A, Х ; Exchange the higher and lower bytes ADD [HL] ; Add the lower byte Α. XCH Х ; Exchange the higher and lower bytes Α, INCW HL ; Go to the higher save area ADDC Α, [HL] ; Add the higher byte (including the carry of the lower byte) INCW ; Go to the next data HLDBNZ в, \$LMAIN400 ; Has the total value been calculated? No, MOV #4 С, ; Specify the divisor DIVUW C ; Calculate the average value (AX \leftarrow (AX/C))

MOVW	RADCAVR, AX	;	Save the average value
BR	LMAIN010	;	Go to the next A/D conversion

end

• main.c (C language version) /************************************						
NEC Electronics 78K0/KC2-L Series						

78K0/KC2-L Series Sample Program (Operational Amplifier)						

Amplifying Analog Voltages in PGA Mode						

< <history>></history>						
2009.1 Release						

<<0verview>>

This sample program presents an example of using the operational amplifier. The analog voltage amplified using operational amplifier 0 in PGA mode is A/D converted using the A/D converter, and then the conversion results and the average of four conversion results are saved in the RAM area.

<Primary initial settings>

(Option byte settings)

- Allowing the internal low-speed oscillator to be programmed to stop

- Disabling the watchdog timer
- Setting the internal high-speed oscillation clock frequency to 8 MHz
- Disabling LVI from being started by default

(Settings during initialization immediately after a reset ends)

- Specifying the ROM and RAM sizes
- Setting up I/O ports
 - \rightarrow Specifying the P21/PGAIN pin as an analog input pin
- Checking whether VDD is 2.7 V or more by using the low-voltage detector
- Specifying that the CPU clock and peripheral hardware clock run on the internal high-speed oscillation clock (8 MHz)
- Stopping the internal low-speed oscillator
- Disabling peripheral hardware not to be used
- Setting up operational amplifier 0
 - \rightarrow Specifying the PGA mode as the operating mode
- \rightarrow Setting the gain to fourfold
- Setting up the A/D converter

 \rightarrow Specifying the standard mode as the operating mode and 264/fPRS (about 33 us) as the conversion time

- \rightarrow Specifying PGAIN as the analog input channel
- \rightarrow Enabling the INTAD interrupt
- \rightarrow Enabling the INTAD interrupt for exiting the HALT mode during A/D conversion

<Area in which to save the A/D conversion results>

+------Data Type | Variable Name |-----| A/D conversion result (1st time) | ushAdcBuffer[0] | A/D conversion result (2nd time) | ushAdcBuffer[1] A/D conversion result (3rd time) | ushAdcBuffer[2] A/D conversion result (4th time) | ushAdcBuffer[3] A/D conversion result (average) ushAdcAverage ____+ <I/O port settings> Input: P21 * Set all unused ports that can be specified as output ports as output ports. /*_____ Preprocessing directive (#pragma) */ /* SFR names can be described at the C source level */ #pragma SFR #pragma DI /* DI instructions can be described at the C source level */ #pragma EI /* EI instructions can be described at the C source level */ /* NOP instructions can be described at the C source level */ #pragma NOP /* HALT instructions can be described at the C source level */ #pragma HALT Initialization after RESET void hdwinit(void) { unsigned char ucCounter; /* Count variable */ /*-----Disable interrupts -----*/ DI(); /* Disable interrupts */ /*_____

Specify the ROM and RAM sizes

```
_____
Note that the values to specify vary depending on the model.
Enable the settings for the model to use. (The uPD78F0588 is the default model.)
*/
 /* Setting when using uPD78F0586 */
 /*IMS =
      0x42;*/
                 /* Specify the ROM and RAM sizes */
 /* Setting when using uPD78F0587 */
 /*IMS = 0x04;*/
                 /* Specify the ROM and RAM sizes */
 /* Setting when using uPD78F0588 */
IMS = 0xC8;
                 /* Specify the ROM and RAM sizes */
/*_____
            _____
Initialize port 0
           -----*/
ΡÛ
     = 0b00000000; /* Set the P00 to P02 output latches to low level */
PM0
     = Ob11111000; /* Specify P00 to P02 as output ports */
              /* P00 to P02: Unused */
/*-----
Initialize port 1
*/
ADPC1 = 0b00000111; /* Specify P10 to P12 as digital I/O ports */
     = 0b00000000; /* Set the P10 to P17 output latches to low level */
Р1
PM1
     = Ob0000000; /* Specify P10 to P17 as output ports */
              /* P10 to P17: Unused */
/*_____
Initialize port 2
*/
ADPC0 = 0b11111101; /* Specify P21 as an analog input pin */
              /* Specify P20, P22 to P27 as digital I/O pins */
     = 0b00000000; /* Set the P20 to P27 output latches to low level */
P2
PM2
     = 0b00000010; /* Specify P21 as an input port */
              /* Specify P20, P22 to P27 as output ports */
              /* P21: Use as PGAIN */
              /* P20, P22 to P27: Unused */
/*-----
Initialize port 3
-----*/
P3
     = 0b00000000; /* Set the P30 to P33 output latches to low level */
PM3
     = Ob11110000; /* Specify P30 to P33 as output ports */
              /* P30 to P33: Unused */
/*_____
Initialize port 4
```

```
-----*/
  Р4
      = 0b00000000; /* Set the P40 to P42 output latches to low level */
      = Ob11111000; /* Specify P40 to P42 as output ports */
  PM4
               /* P40 to P42: Unused */
 /*-----
  Initialize port 6
 -----*/
      = Ob00000000; /* Set the P60 to P63 output latches to low level */
  P6
  PM6
      = Ob11110000; /* Specify P60 to P63 as output ports */
               /* P60 to P63: Unused */
 /*-----
  Initialize port 7
 -----*/
  P7
      = 0b00000000; /* Set the P70 to P75 output latches to low level */
  PM7
      = Ob11000000; /* Specify P70 to P75 as output ports */
               /* P70 to P75: Unused */
 /*_____
  Initialize port 12
 -----*/
      = Ob00000000; /* Set the P120 output latch to low level */
  P12
  PM12 = 0b11111110; /* Specify P120 as an output port */
               /* P120 to P125: Unused */
 /*_____
  Low-voltage detection
 _____
  The low-voltage detector is used to check whether VDD is 2.7 V or more.
 */
  /* Set up the low-voltage detector */
  LVIMK = 1;
              /* Disable the INTLVI interrupt */
               /* Specify VDD as the detection voltage */
  LVISEL = 0;
  LVIS = 0b00001001; /* Set the low-voltage detection level (VLVI) to 2.84 ±0.1 V */
  LVIMD = 0;
               /* Specify that an interrupt signal is generated when a low
voltage is detected */
  LVION = 1;
               /* Enable low-voltage detection */
  /* Make the system wait until the low-voltage detector stabilizes (10 us or more) */
  for( ucCounter = 0; ucCounter < 2; ucCounter++ ) {</pre>
    NOP();
  }
  /* Make the system wait until VLVI is less than or equal to VDD */
  while(LVIF) {
    NOP();
  }
```

LVION = 0; /* Stop the low-voltage detector */

Specify the clock frequency

-----*/

/*_____

Specify the clock frequency so that the device can run on the internal high-speed oscillation clock.

```
OSCCTL = 0b0000000; /* Clock operation mode */
   /*
             ||||+||+---- Be sure to clear this bit to 0 */
   /*
             |||| ++---- RSWOSC/AMPHXT */
   /*
                       [XT1 oscillator oscillation mode selection] */
             /*
             00: Low power consumption oscillation */
   /*
             01: Normal oscillation */
   /*
             1x: Ultra-low power consumption oscillation */
   /*
             | ++----- EXCLKS/OSCSELS */
   /*
             [Subsystem clock pin operation setting] */
   /*
             (P123/XT1,P124/XT2/EXCLKS) */
   /*
             Specify the use of the pin as an I/O port pin by specifying 000
by also using XTSTART */
   /*
             ++---- EXCLK/OSCSEL */
   /*
                        [High-speed system clock pin operation setting] */
   /*
                         (P121/X1,P122/X2/EXCLK) */
   /*
                         00: Input port */
   /*
                         01: X1 oscillation mode */
   /*
                         10: Input port */
   /*
                         11: External clock input mode */
   PCC
         = 0b0000000; /* Select the CPU clock (fCPU) */
   /*
             |||+|+++---- CSS/PCC2/PCC1/PCC0 */
   /*
             [CPU clock (fCPU) selection] */
                         0000:fXP */
   /*
             /*
             0001:fXP/2 */
   /*
             0010:fXP/2^2 */
   /*
             0011:fXP/2^3 */
   /*
             0100:fXP/2^4 */
             /*
                        1000:fSUB/2 */
   /*
             1001:fSUB/2 */
             1010:fSUB/2 */
   /*
   /*
             1011:fSUB/2 */
   /*
             1100:fSUB/2 */
   /*
             (Other than the above: Setting prohibited) */
   /*
             ||| +----- Be sure to clear this bit to 0 */
   /*
             | |+----- CLS */
   /*
             [CPU clock status] */
             |+---- XTSTART */
   /*
   /*
                        [Subsystem clock pin operation setting] */
   /*
             Specify the use of the pin by also using EXCLKS and OSCSELS */
```

/*	+ Be sure to clear this bit to 0 */						
RCM =	0b0000010;/* Select the operating mode of the internal oscillator */						
/*	+ RSTOP */						
/*	[Internal high-speed oscillator oscillating/stopped] */						
/*	0: Internal high-speed oscillator oscillating */						
/*	1: Internal high-speed oscillator stopped */						
/*	+ LSRSTOP */						
/*	[[Internal low-speed oscillator oscillating/stopped] */						
/*	0: Internal low-speed oscillator oscillating */						
/*	1: Internal low-speed oscillator stopped */						
/*	+++++ Be sure to clear this bit to 0 */						
/*	RSTS */						
/*	[Status of internal high-speed oscillator] */						
MOC =	0b10000000:/* Select the operating mode of the high-speed system clock */						
/*	++++++ Be sure to clear this bit to 0 */						
/*	+ MSTOP */						
/*	[Control of high-speed system clock operation] */						
/*	0: X1 oscillator operating/external clock from EXCLK pin is						
enabled */							
/*	1: X1 oscillator stopped/external clock from EXCLK pin is						
disabled */							
MCM =	0b0000000; /* Select the clock to supply */						
/*	+++ XSEL/MCM0 */						
/*	[[[]] [Clock supplied to main system and peripheral hardware] */						
/*	00: Main system clock (fXP) */						
/*	= internal high-speed oscillation clock (fIH) */						
/*	Peripheral hardware clock (fPRS) */						
/*	= internal high-speed oscillation clock (fIH) */						
/*	01: Main system clock (fXP) */						
/*	= internal high-speed oscillation clock (fIH) */						
/*	Peripheral hardware clock (fPRS) */						
/*	= internal high-speed oscillation clock (fIH) */						
/*	10: Main system clock (fXP) */						
/*	= internal high-speed oscillation clock (fIH) */						
/*	Peripheral hardware clock (fPRS) */						
/*	= high-speed system clock (fIH) */						
/*	11: Main system clock (fXP) */						
/*	= high-speed system clock (fIH) */						
/*	Peripheral hardware clock (fPRS) */						
/*	= high-speed system clock (fIH) */						
/*	+ MCS */						
/*	[Main system clock status] */						
/*	+++++ Be sure to clear this bit to 0 */						
-							
PER0 =	0b00000000; /* Control the real-time counter control clock */						

```
/*
           |+++++++---- Be sure to clear this bit to 0 */
 /*
           +----- RTCEN: */
 /*
                     [Real-time counter control clock] */
 /*
                      0: Stop supply of control clock */
 /*
                      1: Supply control clock */
/*_____
 Disable peripheral hardware not to be used
-----*/
 /* 16-bit timer/event counter 00 */
 TMC00 = 0b0000000; /* Disable the counter */
 /* 8-bit timer/event counters 50 and 51 */
 TMC50 = 0b0000000; /* Disable timer 50 */
 TMC51 = 0b0000000; /* Disable timer 51 */
 /* 8-bit timers H0 and H1 */
 TMHMD0 = 0b0000000; /* Stop timer H0 */
 TMHMD1 = 0b0000000; /* Stop timer H1 */
 /* Real-time counter */
 RTCC0 = 0b0000000; /* Stop the counter */
 /* Clock output controller */
 CKS
       = 0b0000000; /* Stop the clock frequency divider */
 /* Operational amplifier */
 AMP1M = Ob00000000; /* Stop operational amplifier 1 */
 /* Serial interface UART6 */
 ASIM6 = 0b0000001; /* Disable the interface */
 /* Serial interface IICA */
 IICACTL0 = 0b0000000; /* Disable the interface */
 /* Serial interfaces CSI10 and CSI11 */
 CSIM10 = 0b0000000; /* Disable CSI10 */
 CSIM11 = 0b0000000; /* Disable CSI11 */
 /* Interrupts */
 MK0
      = 0 \times FFFF;
                     /* Disable all interrupts */
       = 0 \times FFFF;
 MK1
 EGPCTL0 = 0b00000000; /* Disable the detection of all external interrupts */
 EGPCTL1 = 0b0000000;
 /* Key interrupts */
     = 0b00000000;/* Disable all key interrupts */
 KRM
```

```
/*_____
  Set up operational amplifier 0
 -----*/
  AMPOM = 0b01000000; /* Operational amplifier 0 control register */
  /*
         |||||++--- AMP0VG1/0
                                                       */
  /*
         [PGA mode of operational amplifier 0 gain selection]
                                                       */
  /*
         00: x4
                                                       */
  /*
         01: x8
                                                       */
  /*
         10: x16
                                                       */
         /*
                11: x32
                                                       */
  /*
         ||++++---- Be sure to clear this bit to 0
                                                       */
  /*
         ++---- OPAMP0E/PGAEN
                                                       */
  /*
                [Operational amplifier 0 operation control]
                                                       */
  /*
                                                       * /
                 00: Stop operational amplifier 0 operation
  /*
                 01: Enable operational amplifier 0 (PGA mode only) operation */
  /*
                 10: Enable operational amplifier 0 (single-amplifier
                                                       */
  /*
                    mode only) operation
                                                       */
  /*
                 11: Enable operational amplifier 0 (simultaneous operation */
  /*
                    in the PGA and single-amplifier modes) operation */
 /*-----
  Set up the A/D converter
 -----*/
  ADM0 = 0b00000000; /* Specify the standard mode as the operating mode and 264/fPRS as
the conversion time */
  ADS
      = 0b01000000; /* Specify PGAIN as the analog input channel */
  ADIF = 0;
               /* Clear the INTAD interrupt request */
               /* Enable the INTAD interrupt */
  ADMK = 0;
 }
 Main loop
 void main(void)
 {
  unsigned short ushAdcBuffer[4]; /* A/D conversion results (1st to 4th) */
```

```
unsigned short ushAdcAverage; /* Average A/D conversion result */
  signed short shAdcAdjust;
                           /* Corrected A/D conversion result */
  unsigned char ucCounter; /* Count variable */
  unsigned short ushWork; /* Work variable */
  /* Corrected A/D conversion result (to handle the effects of the input offset voltage
of the PGA) */
  const signed short aAdcAdjust = ( -5 ); /* Corrected value -5 */
  shAdcAdjust = aAdcAdjust; /* Read the corrected A/D conversion results */
  while (1) {
 /*_____
  A/D conversion
  */
     ADCE = 1; /* Start the A/D voltage comparator */
     /* Perform the specified number of A/D conversions and save the conversion results
* /
     for (ucCounter = 0; ucCounter < 4; ucCounter++) {</pre>
        ADIF = 0; /* Clear the INTAD interrupt request */
        ADCS = 1; /* Start A/D conversion */
        /* Make the system wait until A/D conversion ends */
        HALT(); /* Enter the HALT mode (Exit the HALT mode by generating an INTAD
interrupt) */
        ushWork = ADCR; /* Read the A/D conversion results */
        ADCS = 0;
                      /* Stop A/D conversion */
        /* Save and correct the A/D conversion results (to handle the effects of the
input offset voltage of the PGA) */
        ushAdcBuffer[ucCounter] = ( ushWork + shAdcAdjust );
     }
     ADCE = 0; /* Stop the A/D voltage comparator */
 /*_____
  Average-value calculation of A/D conversion results
```

APPENDIX B USING 78K0/KC2-L 44-PIN PRODUCTS

All 78K0/KC2-L sample programs are intended for 48-pin products. To use a 78K0/KC2-L sample program for a 44-pin product, specify the following settings:

(1) Initial settings of ports

- Setting up port 0
 Change the value of bit 2 of port mode register 0 (PM0) from "0" to "1".
- Setting up port 4

Change the value of bit 2 of port mode register 4 (PM4) from "0" to "1".

Setting up port 7
 Change the values of bits 5 and 4 of port mode register 7 (PM7) from "00" to "11".

(2) Disabling unused peripheral hardware

Delete the instruction used to set up the clock output selection register (CKS).

APPENDIX C REVISION HISTORY

Edition	Date Published	Page	Revision
1st edition	September 2009	_	_

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